

### General Description

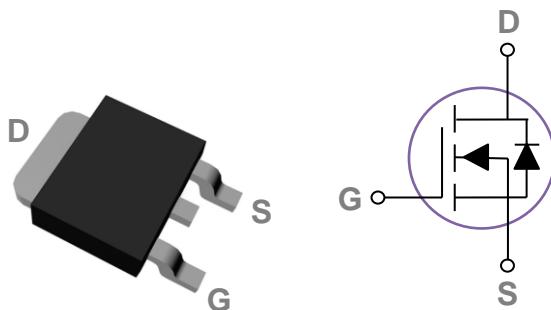
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BVDSS	RDS(ON)	ID
40V	2.3mΩ	135A

### Features

- 40V, 135A,  $RDS(ON) = 2.3m\Omega$  @  $VGS = 10V$
- Improved dv/dt capability
- Fast switching
- Green Device Available

### TO252 Pin Configuration



### Applications

- Motor Drive
- Power Tools
- LED Lighting
- Quick Charger

### Absolute Maximum Ratings $T_c=25^\circ C$ unless otherwise noted

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	40	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current – Continuous ( $T_c=25^\circ C$ )	135	A
	Drain Current – Continuous ( $T_c=100^\circ C$ )	85	A
$I_{DM}$	Drain Current – Pulsed <sup>1</sup>	540	A
EAS	Single Pulse Avalanche Energy <sup>2</sup>	312	mJ
IAS	Single Pulse Avalanche Current <sup>2</sup>	79	A
$P_D$	Power Dissipation ( $T_c=25^\circ C$ )	90	W
	Power Dissipation – Derate above $25^\circ C$	0.73	W/ $^\circ C$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ C$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ C$

### Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	62	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	1.38	$^\circ C/W$



40V N-Channel MOSFETs

PDD49E8BH

**Electrical Characteristics ( $T_J=25\text{ }^{\circ}\text{C}$ , unless otherwise noted)****Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$ , $I_D=250\mu\text{A}$	40	---	---	V
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=40\text{V}$ , $V_{GS}=0\text{V}$ , $T_J=25\text{ }^{\circ}\text{C}$	---	---	1	$\mu\text{A}$
		$V_{DS}=32\text{V}$ , $V_{GS}=0\text{V}$ , $T_J=100\text{ }^{\circ}\text{C}$	---	---	10	$\mu\text{A}$
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=\pm 20\text{V}$ , $V_{DS}=0\text{V}$	---	---	$\pm 100$	nA

**On Characteristics**

$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}$ , $I_D=20\text{A}$	---	1.9	2.3	$\text{m}\Omega$
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_D = 250\mu\text{A}$	2	3	4	V
$g_{fs}$	Forward Transconductance	$V_{DS}=10\text{V}$ , $I_S=3\text{A}$	---	11	---	S

**Dynamic and switching Characteristics<sup>3</sup>**

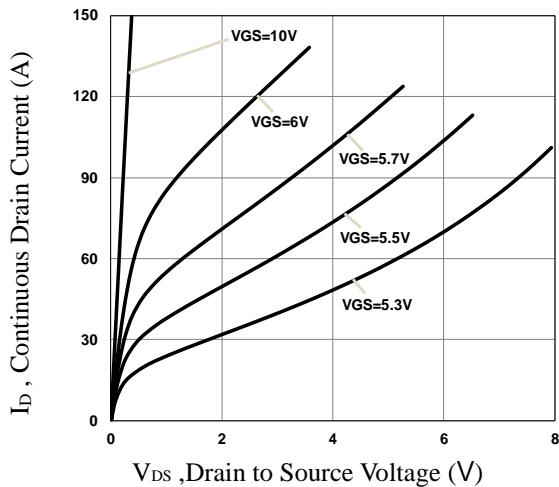
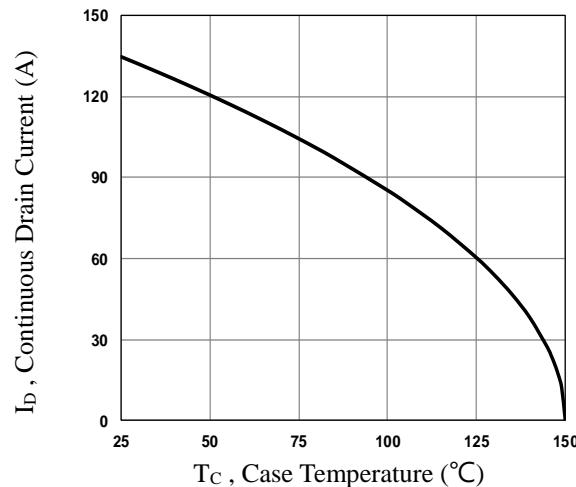
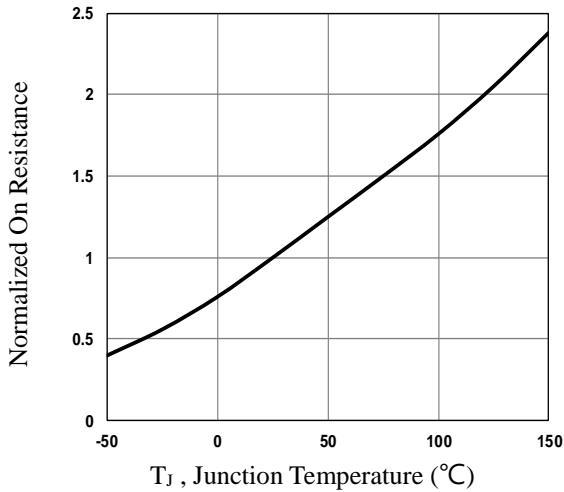
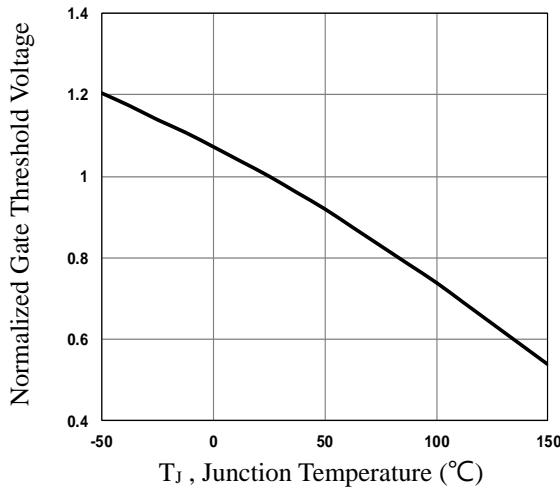
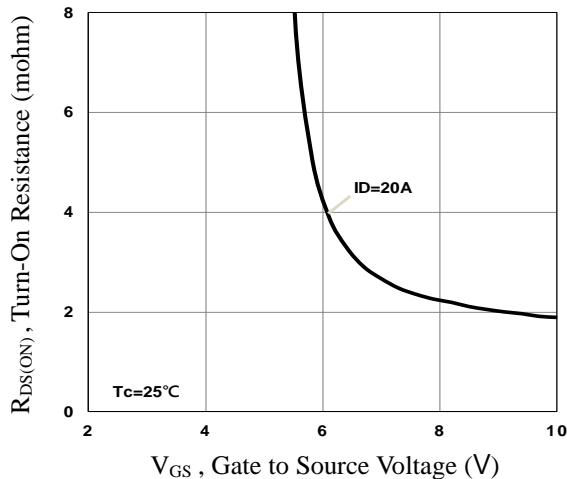
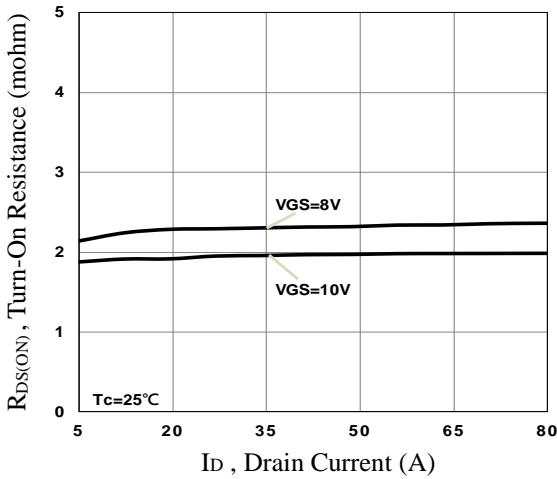
$Q_g$	Total Gate Charge	$V_{DS}=20\text{V}$ , $V_{GS}=10\text{V}$ , $I_D=70\text{A}$	---	38	60	nC
$Q_{gs}$	Gate-Source Charge		---	13	20	
$Q_{gd}$	Gate-Drain Charge		---	12	20	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=20\text{V}$ , $V_{GS}=10\text{V}$ , $R_G=6\Omega$ $I_D=70\text{A}$	---	8	12	ns
$T_r$	Rise Time		---	12	20	
$T_{d(off)}$	Turn-Off Delay Time		---	15	25	
$T_f$	Fall Time		---	20	30	
$C_{iss}$	Input Capacitance	$V_{DS}=20\text{V}$ , $V_{GS}=0\text{V}$ , $F=1\text{MHz}$	---	2650	4000	pF
$C_{oss}$	Output Capacitance		---	1130	1700	
$C_{rss}$	Reverse Transfer Capacitance		---	50	75	
$R_g$	Gate resistance	$V_{GS}=0\text{V}$ , $V_{DS}=0\text{V}$ , $F=1\text{MHz}$	---	0.95	---	$\Omega$

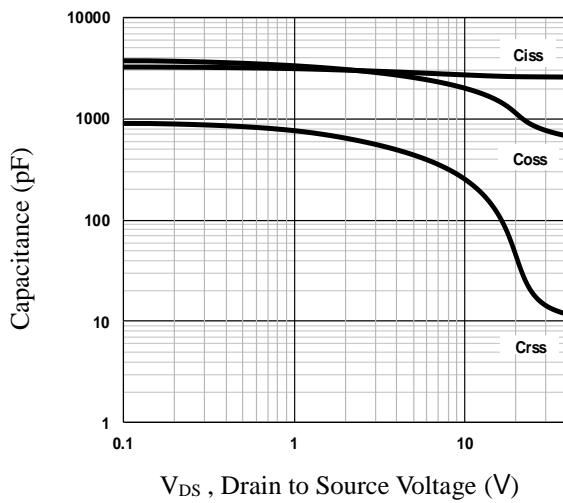
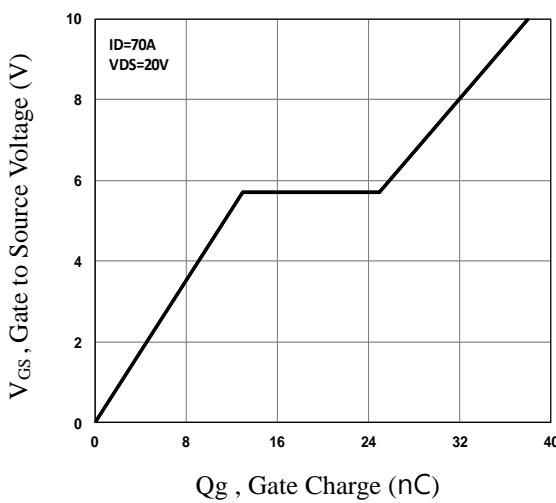
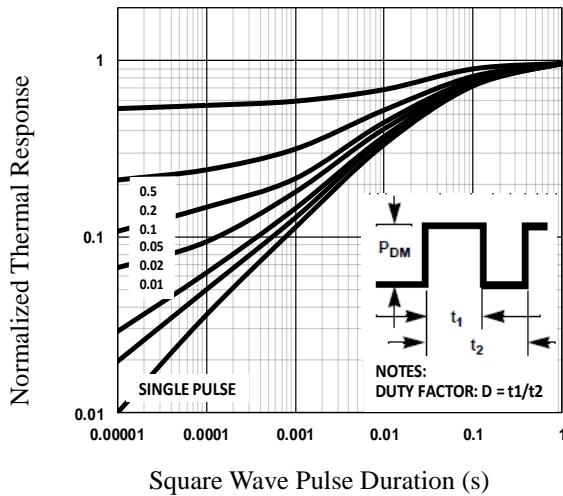
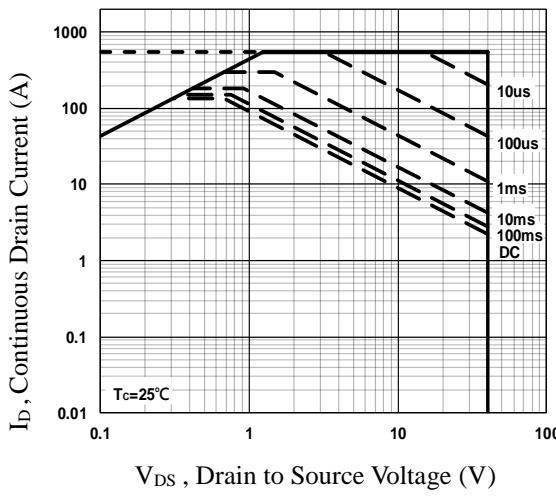
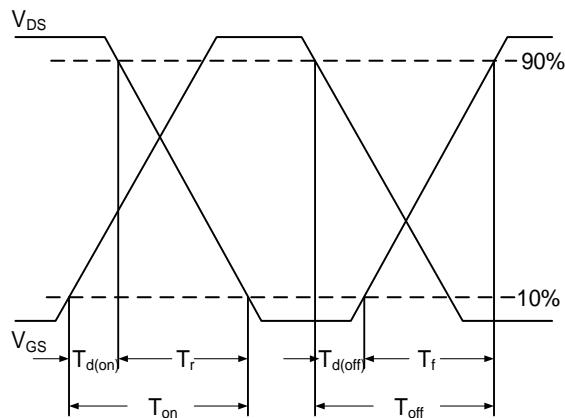
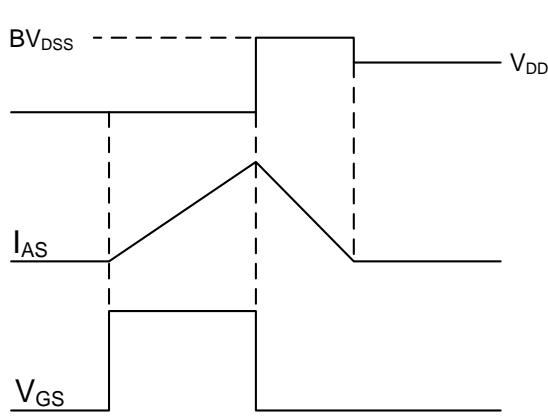
**Drain-Source Diode Characteristics and Maximum Ratings**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous Source Current	$V_G=V_D=0\text{V}$ , Force Current	---	---	135	A
			---	---	270	A
$V_{SD}$	Diode Forward Voltage	$V_{GS}=0\text{V}$ , $I_s=1\text{A}$ , $T_J=25\text{ }^{\circ}\text{C}$	---	---	1	V
$T_{rr}$	Reverse Recovery Time	$V_R=30\text{V}$ , $I_s=10\text{A}$	---	70	---	ns
			---	100	---	nC
$Q_{rr}$	Reverse Recovery Charge	$dI/dt=100\text{A}/\mu\text{s}$ $T_J=25\text{ }^{\circ}\text{C}$	---	---	---	

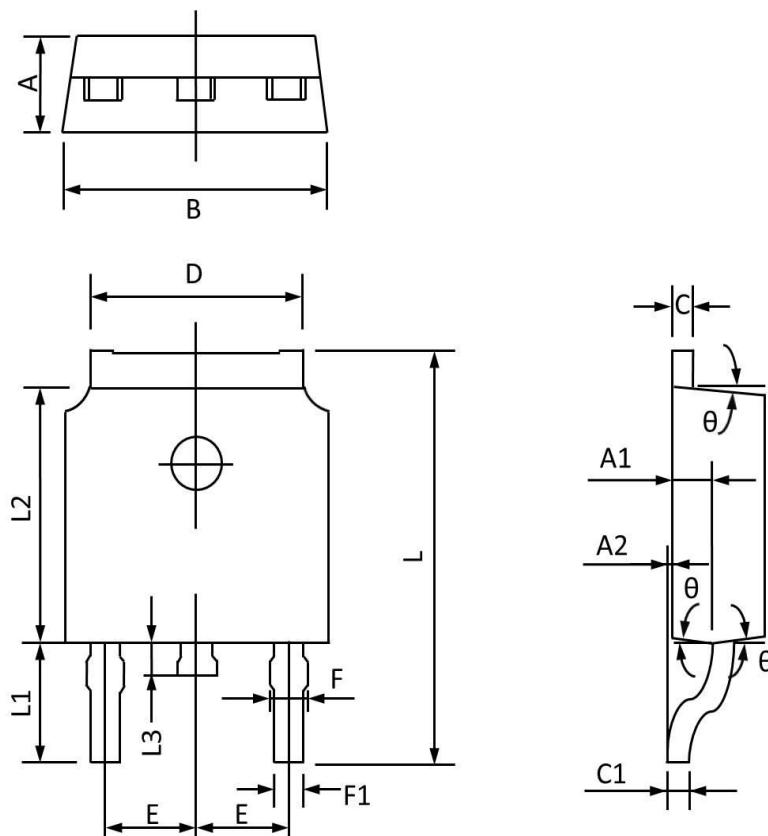
Note :

- Repetitive Rating : Pulsed width limited by maximum junction temperature.
- $V_{DD}=25\text{V}$ ,  $V_{GS}=10\text{V}$ ,  $L=0.1\text{mH}$ ,  $I_{AS}=79\text{A}$ ,  $R_G=25\Omega$ , Starting  $T_J=25\text{ }^{\circ}\text{C}$ .
- Essentially independent of operating temperature.


**Fig.1 Typical Output Characteristics**

**Fig.2 Continuous Drain Current vs.  $T_c$** 

**Fig.3 Normalized  $R_{DSON}$  vs.  $T_j$** 

**Fig.4 Normalized  $V_{th}$  vs.  $T_j$** 

**Fig.5 Turn-On Resistance vs.  $V_{GS}$** 

**Fig.6 Turn-On Resistance vs.  $I_D$**


**Fig.7 Capacitance Characteristics**

**Fig.8 Gate Charge Characteristics**

**Fig.9 Normalized Transient Impedance**

**Fig.10 Maximum Safe Operation Area**

**Fig.11 Switching Time Waveform**

**Fig.12 EAS Waveform**

## TO252 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	2.450	2.150	0.096	0.085
A1	1.200	0.910	0.047	0.036
A2	0.150	0.000	0.006	0.000
B	6.800	6.300	0.268	0.248
C	0.580	0.350	0.023	0.014
C1	0.550	0.380	0.022	0.015
D	5.500	5.100	0.217	0.201
E	2.390	2.000	0.094	0.079
F	0.940	0.600	0.037	0.024
F1	0.860	0.500	0.034	0.020
L	10.400	9.400	0.409	0.370
L1	3.000	2.400	0.118	0.094
L2	6.200	5.300	0.244	0.209
L3	1.200	0.600	0.047	0.024
θ	9°	3°	9°	3°